Metallized Polypropylene Film EMI Suppression Capacitors R47, Class X2, 520 VAC, 85°C (Automotive Grade)



Overview

The R47 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V-0.

Automotive Grade devices (up to 22.5 mm lead spacing) meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Applications

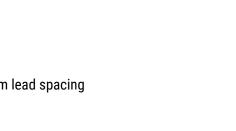
For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock.

Benefits

- Approvals: ENEC, UL, cUL
- X2 CLASS (IEC 60384-14)
- Rated voltage: 520VAC 50/60Hz
- Capacitance range: 0.0047 2.2 μF
- Lead spacing: 10.0 37.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/85/56, IEC 60068-1
- Tape & Reel in accordance with IEC 60286-2
- · RoHS compliant and lead-free terminations
- Operating temperature range of -40°C to +85°C
- 100% screening factory test at 2,700 VDC/1,700 VAC
- Self healing properties
- · Automotive (AEC-Q200) grades available up to 22.5 mm lead spacing

Part Number System

R47	5	l. I	2100	00	01	М
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Lead and Packaging Code	Internal Use	Capacitance Tolerance
X2, Metallized Polypropylene	5 = 520	F = 10.0 I = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	01 02 03	K = ±10% M = ±20%



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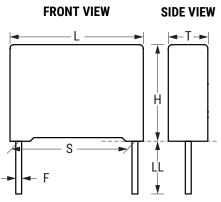
Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Ammo Pack	H ₀ = 18.5 ±0.5	DQ
10	Other Lead and Packaging Options		
15	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	СК
22.5	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25+2/-1	50
	Standard Lead and Packaging Options		
	Bulk (Tray) – Short Leads	4 +2/-0	00
27.5	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	CK ¹
37.5	Other Lead and Packaging Options		
•	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50

¹ Not for all sizes, see "Packaging Quantities" table.



Dimensions – Millimeters



	S T H				4	I	L	F		
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	
10.0	±0.4	4.0	+0.2/-0.5	9.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05	
10.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05	
10.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05	
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05	
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05	
15.0	±0.4	6.0	+0.2/-0.5	17.5	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05	
15.0	±0.4	7.5	+0.2/-0.5	13.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05	
15.0	±0.4	7.5	+0.2/-0.5	18.5	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05	
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05	
15.0	±0.4	9.0	+0.2/-0.5	12.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05	
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05	
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05	
15.0	±0.4	13.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05	
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	6.5	+0.2/-0.5	13.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	8.5	+0.2/-0.5	17.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	11.0	+0.2/-0.5	20.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05	
27.5	±0.4	9.0	+0.2/-0.7	17.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
27.5	±0.4	11.0	+0.2/-0.7	20.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
27.5	±0.4	13.0	+0.2/-0.7	22.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
27.5	±0.4	14.0	+0.2/-0.7	28.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
27.5	±0.4	18.0	+0.2/-0.7	33.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
27.5	±0.4	22.0	+0.2/-0.7	37.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05	
37.5	±0.4	11.0	+0.3/-0.7	22.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05	
37.5	±0.4	13.0	+0.3/-0.7	24.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05	
37.5	±0.4	16.0	+0.3/-0.7	28.5	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05	
37.5	±0.4	19.0	+0.3/-0.7	32.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05	
37.5	±0.4	20.0	+0.3/-0.7	40.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05	
	Note: See Ordering Options Table for lead length (LL/H_0) options.									

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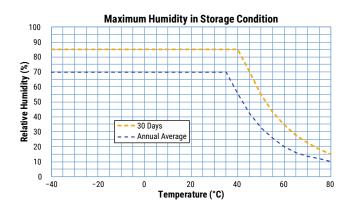


Performance Characteristics

Dielectric	Polypropylene film								
Plates	Metal layer deposited by	Metal layer deposited by evaporation under vacuum							
Winding	Non-inductive type								
Leads	Tinned wire								
Protection	Plastic case, thermosetting	g resin filled. Box material is so	lvent resistant and flame reta	ardant according to UL94.					
Related Documents	IEC 60384-14, EN 60384	-14							
Rated Voltage V _R	520 VAC (50/60 Hz)								
Recommended DC Voltage	≤ 1,000 VDC								
Capacitance Range	4,700 pF to 1 µF								
Capacitance Values	E6 series (IEC 60063) me	asured at 1 kHz and +20 ±1°	C						
Capacitance Tolerance	±10%, ±20%								
Temperature Range	-40°C to +85°C	-40°C to +85°C							
Climatic Category	40/85/56 IEC 60068-1	40/85/56 IEC 60068-1							
	Storage time: ≤ 24 months from the date marked on the label package								
	Average relative humidity per year ≤ 70%								
Storage Conditions	RH \leq 85% for 30 days randomly distributed throughout the year								
	Dew is absent								
	Temperature: -40 to 80°C (see "Maximum Humidity in Storage Conditions" graph below)								
Approvals	ENEC, UL, cUL								
Dissipation Factor (tanδ)	≤ 0.1% (0.06%*) at 1 kHz ,	+25°C ±5°C (* typical value))						
Test Voltage Between Terminals	the requirements in applic	The 100% screening factory test is carried out at 2,700 VDC/1,700 VAC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. This test cannot be repeated, as there is a risk of damaging the capacitor. KEMET is not liable in such cases							
		Measured at +25°C ±5°C, a	according to IEC 60384–2						
Insulation Resistance		Minimum Values B	etween Terminals						
insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 µF					
	100 VDC	1 minute	≥ 1 • 10 ⁵ MΩ	≥ 30,000 MΩ • μF					
In DC Applications	Recommended voltage ≤	1,000 VDC							



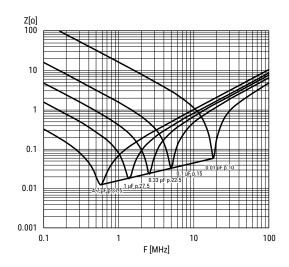
Performance Characteristics cont.



Qualification

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit the website at www.aecouncil.com.

Impedance Graph





Environmental Test Data

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384-14	1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s ²
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s²
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V_{R} + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

Approvals

Mark	Specification	File Number	
	EN/IEC 60384-14	CA08.00101	
c FL [®] us	UL 60384–14 and CAN/CSA E60384–14 (440VAC)	E97797	

Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.





Table 1 – Ratings & Part Number Reference

Capacitance Dimensions in mm		Lead Spacing dV/dt		KEMET	Legacy Part		
Value (µF)	Т	Н	L	(S)	(V/µs)	Part Number	Number
0.0047	4.0	9.0	13.0	10.0	750	475F1470(1)01(2)	R475F1470(1)01(2)
0.0068	5.0	11.0	13.0	10.0	750	475F1680(1)01(2)	R475F1680(1)01(2)
0.0082	6.0	12.0	13.0	10.0	750	475F1820(1)01(2)	R475F1820(1)01(2)
0.010	6.0	12.0	13.0	10.0	750	475F2100(1)01(2)	R475F2100(1)01(2)
0.010	5.0	11.0	18.0	15.0	600	47512100(1)01(2)	R475I2100(1)01(2)
0.012	5.0	11.0	18.0	15.0	600	47512120(1)01(2)	R475I2120(1)01(2)
0.015	5.0	11.0	18.0	15.0	600	47512150(1)01(2)	R475I2150(1)01(2)
0.018	5.0	11.0	18.0	15.0	600	47512180(1)01(2)	R475I2180(1)01(2)
0.022	6.0	12.0	18.0	15.0	600	47512220(1)01(2)	R475I2220(1)01(2)
0.027	6.0	12.0	18.0	15.0	600	47512270(1)01(2)	R475I2270(1)01(2)
0.033	6.0	12.0	18.0	15.0	600	47512330(1)01(2)	R475I2330(1)01(2)
0.039	7.5	13.5	18.0	15.0	600	47512390(1)01(2)	R475I2390(1)01(2)
0.047	7.5	13.5	18.0	15.0	600	47512470(1)01(2)	R475I2470(1)01(2)
0.047	6.0	17.5	18.0	15.0	600	47512470(1)02(2)	R475I2470(1)02(2)
0.047	9.0	12.5	18.0	15.0	600	47512470(1)03(2)	R475l2470(1)03(2)
0.056	8.5	14.5	18.0	15.0	600	47512560(1)01(2)	R475I2560(1)01(2)
0.068	10.0	16.0	18.0	15.0	600	47512680(1)01(2)	R475I2680(1)01(2)
0.068	7.5	18.5	18.0	15.0	600	47512680(1)02(2)	R475I2680(1)02(2)
0.068	13.0	12.0	18.0	15.0	600	47512680(1)03(2)	R475I2680(1)03(2)
0.082	10.0	16.0	18.0	15.0	600	47512820(1)01(2)	R475I2820(1)01(2)
0.10	11.0	19.0	18.0	15.0	600	47513100(1)01(2)	R475I3100(1)01(2)
0.047	6.0	15.0	26.5	22.5	300	475N2470(1)01(2)	R475N2470(1)01(2)
0.047	6.5	13.5	26.5	22.5	300	475N2470(1)02(2)	R475N2470(1)02(2)
0.068	6.0	15.0	26.5	22.5	300	475N2680(1)01(2)	R475N2680(1)01(2)
0.10	7.0	16.0	26.5	22.5	300	475N3100(1)01(2)	R475N3100(1)01(2)
0.12	8.5	17.0	26.5	22.5	300	475N3120(1)01(2)	R475N3120(1)01(2)
0.15	10.0	18.5	26.5	22.5	300	475N3150(1)01(2)	R475N3150(1)01(2)
0.18	10.0	18.5	26.5	22.5	300	475N3180(1)01(2)	R475N3180(1)01(2)
0.22	11.0	20.0	26.5	22.5	300	475N3220(1)01(2)	R475N3220(1)01(2)
0.27	13.0	22.0	26.5	22.5	300	475N3270(1)01(2)	R475N3270(1)01(2)
0.33	13.0	22.0	26.5	22.5	300	475N3330(1)01(2)	R475N3330(1)01(2)
0.15	9.0	17.0	32.0	27.5	225	475R3150(1)01(2)	R475R3150(1)01(2)
0.18	9.0	17.0	32.0	27.5	225	475R3180(1)01(2)	R475R3180(1)01(2)
0.22	9.0	17.0	32.0	27.5	225	475R3220(1)01(2)	R475R3220(1)01(2)
0.27	9.0	17.0	32.0	27.5	225	475R3270(1)02(2)	R475R3270(1)02(2)
0.33	11.0	20.0	32.0	27.5	225	475R3330(1)02(2)	R475R3330(1)02(2)
0.39	11.0	20.0	32.0	27.5	225	475R3390(1)01(2)	R475R3390(1)01(2)
0.47	13.0	22.0	32.0	27.5	225	475R3470(1)01(2)	R475R3470(1)01(2)
0.56	13.0	22.0	32.0	27.5	225	475R3560(1)01(2)	R475R3560(1)01(2)
0.68	14.0	28.0	32.0 32.0	27.5 27.5	225 225	475R3680(1)01(2)	R475R3680(1)01(2)
0.82	18.0	33.0			225	475R3820(1)01(2)	R475R3820(1)01(2)
1.0 1.2	18.0	33.0	32.0	27.5 27.5	225	475R4100(1)01(2)	R475R4100(1)01(2) R475R4120(1)01(2)
1.2	18.0	33.0 37.0	32.0	27.5	225	475R4120(1)01(2)	
1.5 0.47	22.0 11.0	37.0	32.0 41.5	37.5	150	475R4150(1)01(2) 475W3470(1)01(2)	R475R4150(1)01(2) R475W3470(1)01(2)
0.47	11.0	22.0	41.5	37.5	150	.,.,,	
0.56	13.0	22.0	41.5	37.5	150	475W3560(1)01(2) 475W3680(1)01(2)	R475W3560(1)01(2) R475W3680(1)01(2)
0.82	13.0	24.0	41.5 41.5	37.5	150	475W3680(1)01(2) 475W3820(1)01(2)	R475W3880(1)01(2)
1.0	16.0	28.5	41.5	37.5	150	475W3820(1)01(2) 475W4100(1)01(2)	R475W4100(1)01(2)
1.0	19.0	32.0	41.5	37.5	150	475W4100(1)01(2)	R475W4120(1)01(2)
1.2	19.0	32.0	41.5	37.5	150	475W4120(1)01(2)	R475W4150(1)01(2)
1.5	20.0	40.0	41.5	37.5	150	475W4180(1)01(2)	R475W4180(1)01(2)
2.2	20.0	40.0	41.5	37.5	150	475W4220(1)01(2)	R475W4220(1)01(2)
Capacitance						KEMET	
Value (µF)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	dV/dt (V/µs)	Part Number	Legacy Part Number

(1) Insert lead and packaging code. See table for available options.

(2) $M = \pm 20\%$, $K = \pm 10\%$



Soldering Process

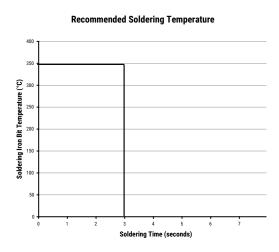
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from 183°C for SnPb eutectic alloys to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

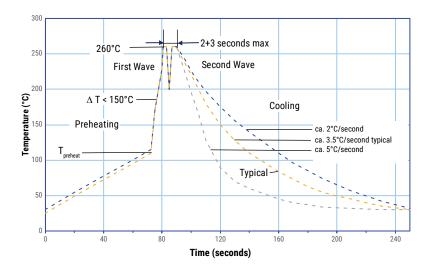
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont.

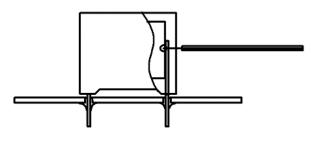
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric	Maxi Prel Tempe	heat	Maximum Peak Soldering Temperature			
Film Material	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm		
Polyester	130°C	130°C	270°C	270°C		
Polypropylene	110°C	130°C	260°C	270°C		
Paper	130°C	140°C	270°C	270°C		
Polyphenylene Sulphide	150°C	160°C	270°C	270°C		

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

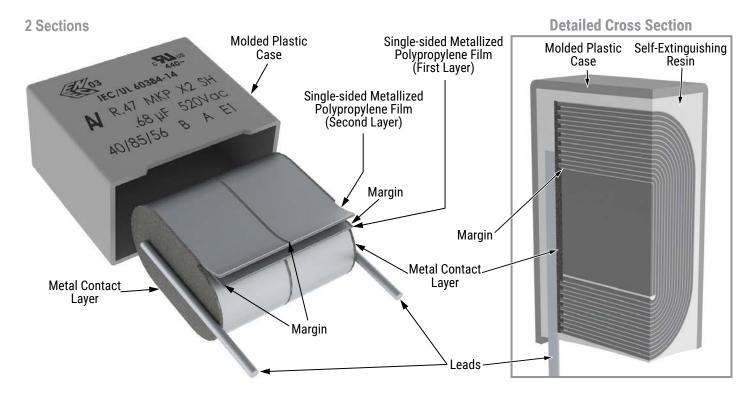
Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

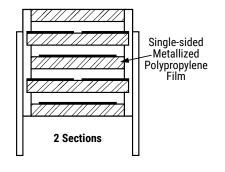
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



Construction

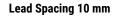


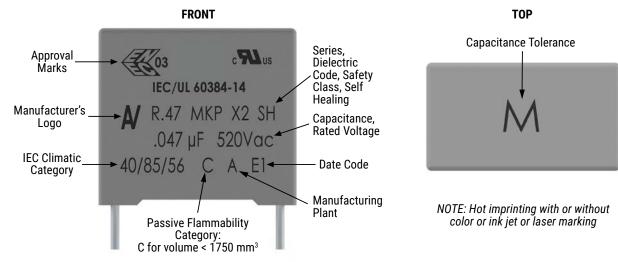
Winding Scheme



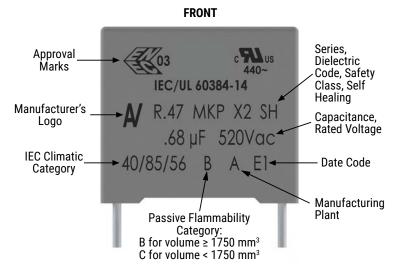


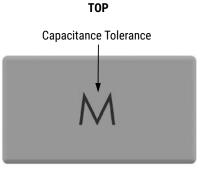
Marking





Lead Spacing 15 mm, 22.5 mm, and 27.5 mm



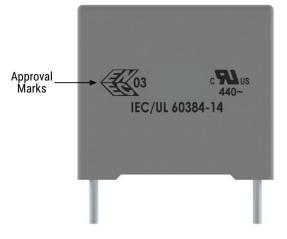


NOTE: Hot imprinting with or without color or ink jet or laser marking



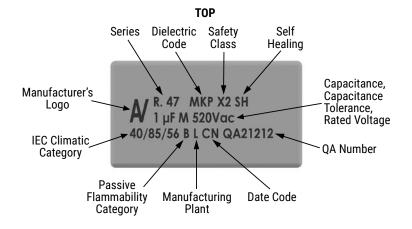
Marking cont.

Lead Spacing 22.5 and 27.5 mm (alternatives*) and 37.5 mm FRONT



*Differences are caused by technology (clichee, laser, or ink) and production line.

Manufacturing Date Code (IEC-60062)									
Y = Year, Z = Month									
Year	Code Month Code								
2010	А	January	1						
2011	В	February	2						
2012	С	March	3						
2013	D	April	4						
2014	E	Мау	5						
2015	F	June	6						
2016	Н	July	7						
2017	J	August	8						
2018	К	September	9						
2019	L	October	0						
2020	М	November	Ν						
2021	Ν	December	D						
2022	Р								
2023	R								
2024	S								
2025	Т								
2026	U								
2027	V								
2028	W								
2029	Х								
2030	А								





Packaging Quantities

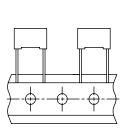
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
	4	9	13	2,000	1,800	750	1,500	1,000
10	5	11	13	1,300	1,500	600	1,250	800
	6	12	13	1,000	1,200	500	1,000	680
	-		10					
	5	11	18	2,000	1,000	600	1,250	800
	6	12	18	1,750	900	500	1,000	680
	6	17.5	18	1,000	700	500	1,000	680
	7.5	13.5	18	1,000	700	350	800	500
15	7.5	18.5	18	900	500	-	800	500
10	8.5	14.5	18	1,000	500	300	700	440
	9	12.5	18	1,000	520	270	650	410
	10	16	18	750	500	300	600	380
	11	19	18	450	350	-	500	340
	13	12	18	750	490	200	480	280
	6	15	26.5	805	500	-	700	464
	6.5	13,5	26.5	800	-	_	-	
	7	16	26.5	700	500	_	550	380
22.5	8.5	17	26.5	468	300	-	450	280
	10	18.5	26.5	396	300	-	350	235
	11	20	26.5	360	250	-	350	217
	13	22	26.5	300	200	-	300	_
		17	00	011	400		450	
	9	17	32	816	408	_	450	_
	11	20	32	560	336	-	350	
27.5	13	22	32	480	288	-	300	_
	14	28	32	352	176	_	-	_
	18	33	32	256	128	_	-	
	22	37	32	168	112	-	_	_
	11	22	41.5	420	252	_	_	_
	13	22	41.5	360	232		-	
27.5						-	<u> </u>	-
37.5	16	28.5	41.5	216	108	-	_	-
	19	32	41.5	192	96	-	_	_
	20	40	41.5	126	84	_	_	_



Lead Taping & Packaging (IEC 60286-2)



Figure 2 Lead Spacing 15 mm



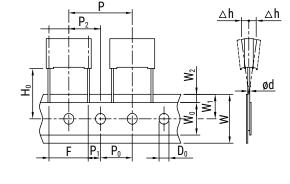
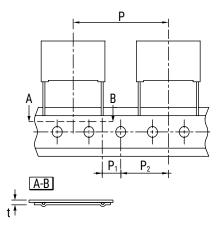


Figure 3 Lead Spacing 22.5 – 27.5 mm



Taping Specification

		Dimensions (mm)					
Description	Symbol						
Description	Cymbol	10	15	22.5	27.5	Tol.	
		Fig. 1	Fig. 2	Fig. 3	Fig. 3		
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05	
Taping lead space	Р	25.4	25.4	38.1	38.1	±1	
Feed hole lead space *	P ₀	12.7	12.7	12.7	12.7	±0.2 **	
Centering of the lead wire	P ₁	7.7	5.2	7.8	5.3	±0.7	
Centering of the body	P ₂	12.7	12.7	19.05	19.05	±1.3	
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1	
Component alignment	Δh	0	0	0	0	±2	
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	±0.5	
Carrier tape width	W	18	18	18	18	+1/-0.5	
Hold down tape width	W ₀	9	10	10	10	Minimum	
Hole position	W ₁	9	9	9	9	±0.5	
Hold down tape position	W ₂	3	3	3	3	Maximum	
Feed hole diameter	D ₀	4	4	4	4	±0.2	
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2	

* 15 mm also available

** Maximum of 1 mm on 20 lead spaces

*** Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

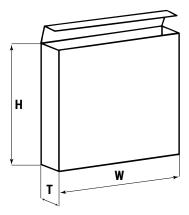
**** $H_0 = 16.5 \text{ mm}$ is available upon request



Lead Taping & Packaging (IEC 60286-2) cont.

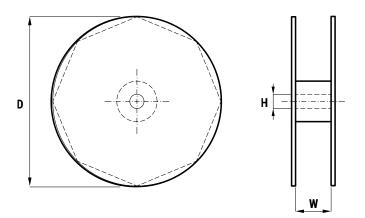
Ammo Specifications

Dimensions (mm)				
Н	W	Т		
360	340	59		



Reel Specifications

Reel Size	Dimensions (mm)		
Reel Size	D	Н	W
Standard	355	30	55 Maximum
Large	500	25	





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